Introduction to Electron Guns for Accelerators

Bruce Dunham

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Outline

•The Basics

•Cathodes

•Details of Different Accelerator Guns

•RF Guns

•SRF Guns

•DC Guns

•Polarized Electron Guns

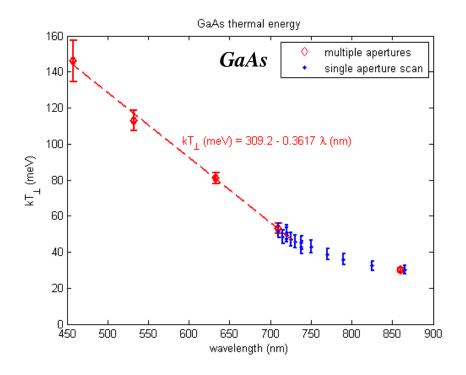
•Photoemission Guns

•High Voltage

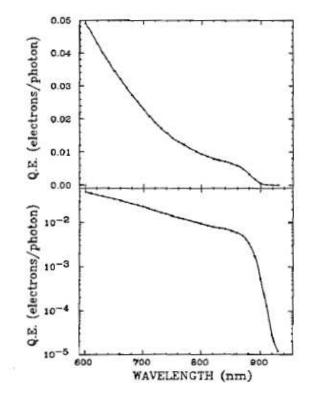
•Vacuum

•Laser System

Thermal emittance

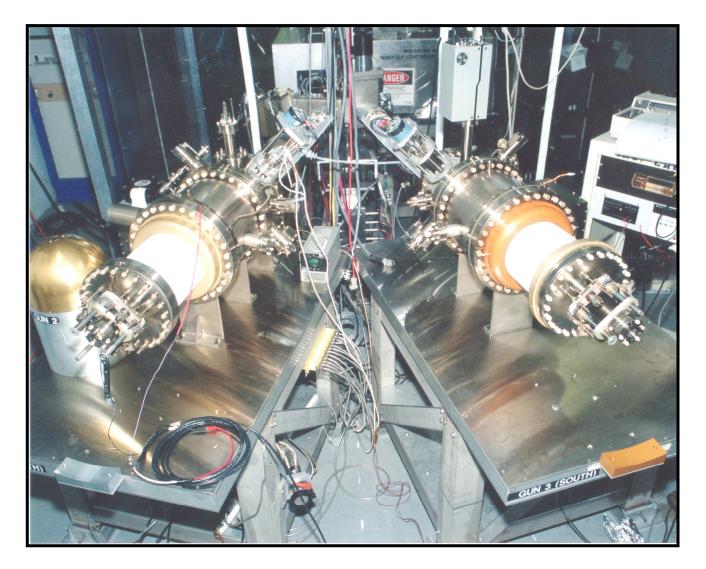


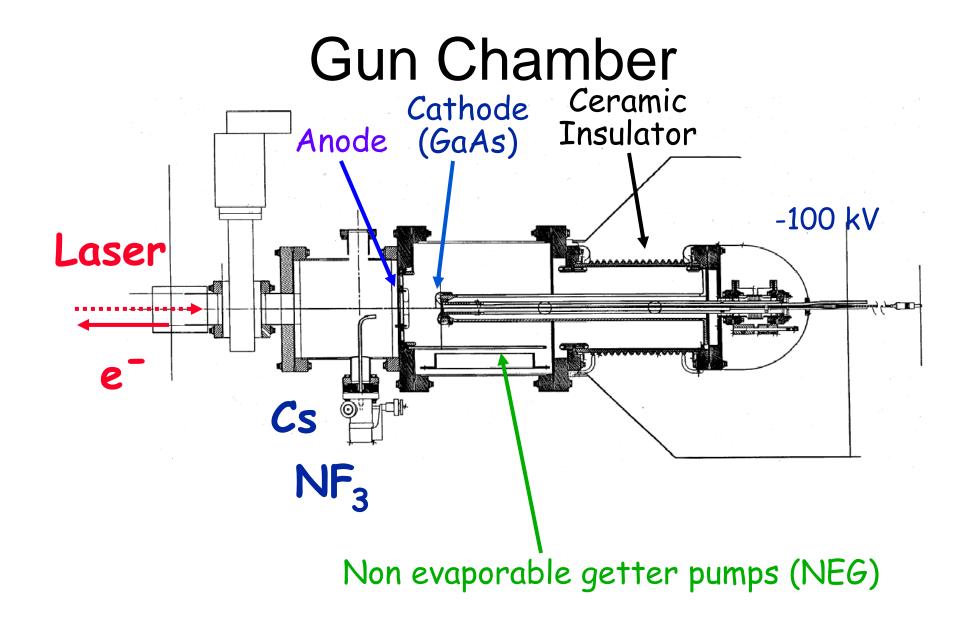
- kT_⊥ = **120 meV** at **520 nm**
- or *0.5 mm-mrad* per *1 mm* rms
- GaAs still best overall performance Beam emittance ∝ sqrt(kT)



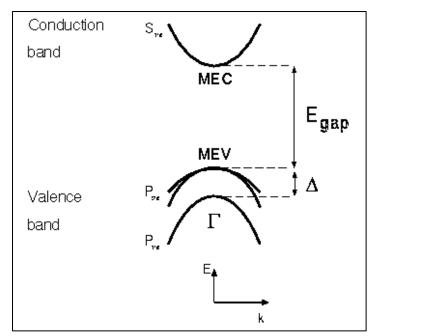
The lowest kT occurs at the worst QE!!

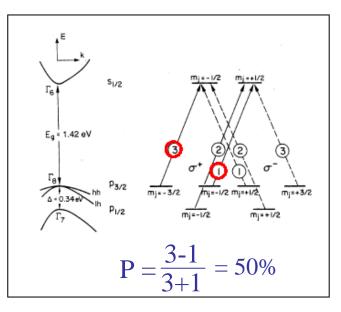
Jefferson Lab 100kV DC Polarized Electron Source





Electron Polarization

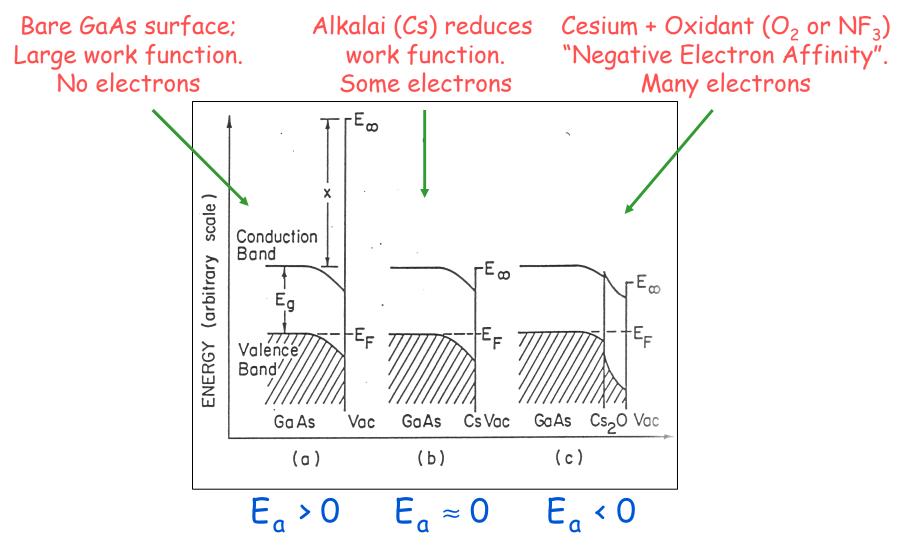




Bulk GaAs

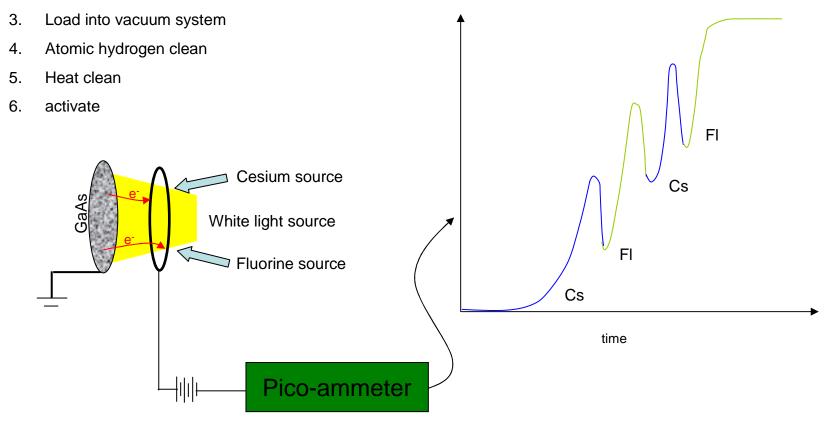
- Circularly polarized light at energy Egap (less than Egap + Δ) excites three electrons in one spin state for every one in the opposite spin state
- Theoretically 50% polarization, actually ~35% polarization
- First used at SLAC, then Jlab, Mainz, Bates

GaAs Surface Preparation



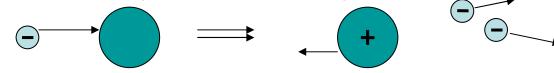
Cathode Activation Yo-Yo

- 1. Chemical etch
- 2. Mount on wafer holder



Vacuum Requirements for GaAs

- Surface Chemistry
 - Reacts with residual gasses
 - Oxide forms on GaAs during heat processes if water is present
- Ions (residual gasses) damage cathode

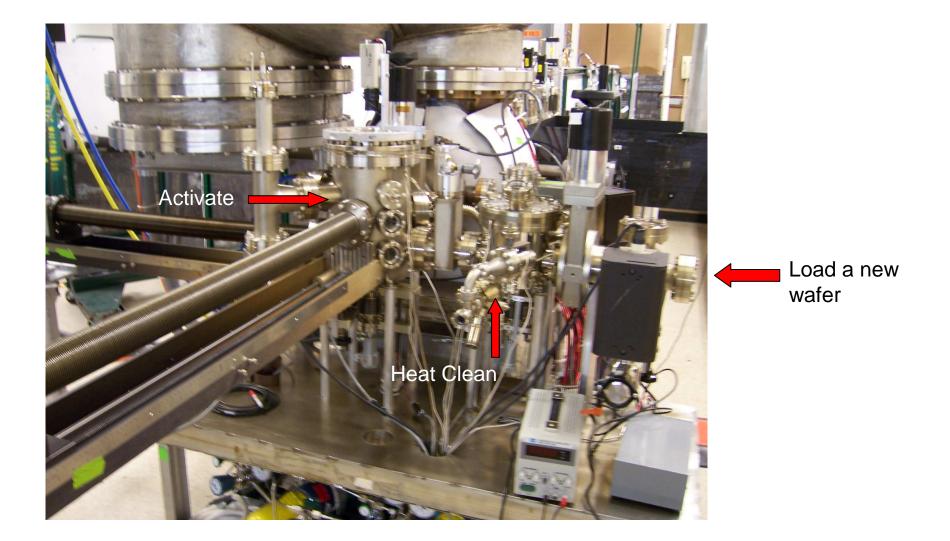


- Excellent (<1x10⁻¹¹ Torr) vacuum obtained through
 - Pumping
 - Getter (chemical) and ion pump
 - Clean materials with low outgassing rates
 - Stainless steels, copper, ceramics
 - Leak Check
 - Bake

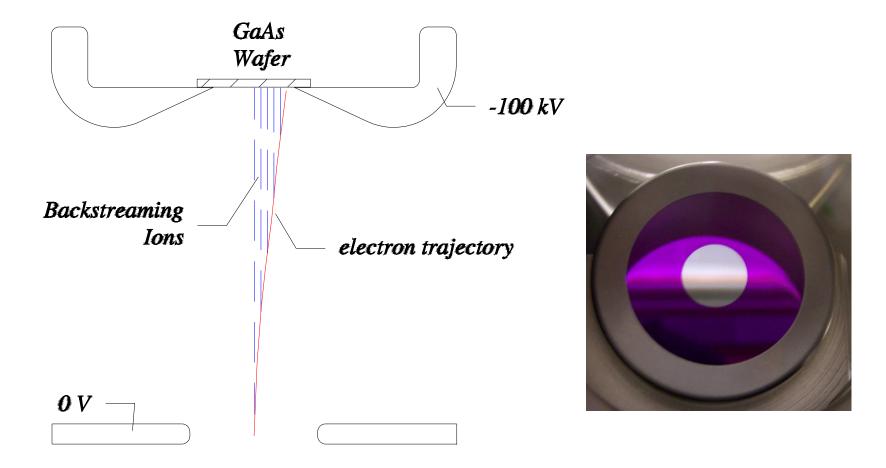


Arrays of NEG pumps provide the best vacuum conditions

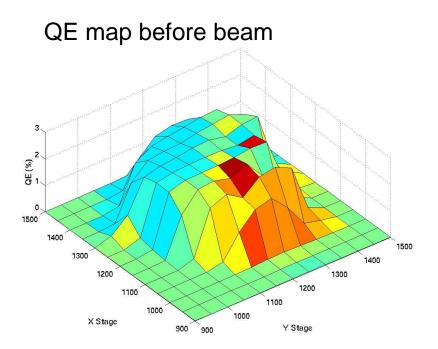
Load lock system for introducing new wafers



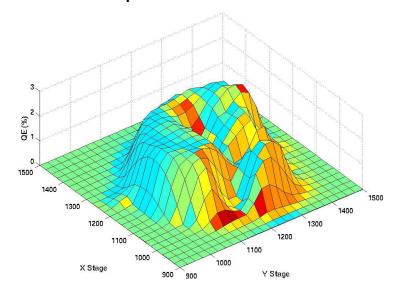
Vacuum and ion backstreaming

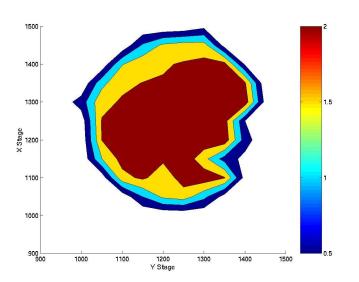


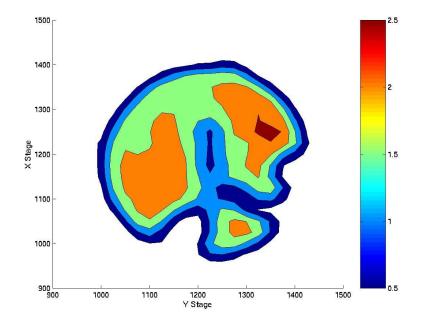
Ion backstreaming is a cause of poor cathode lifetime



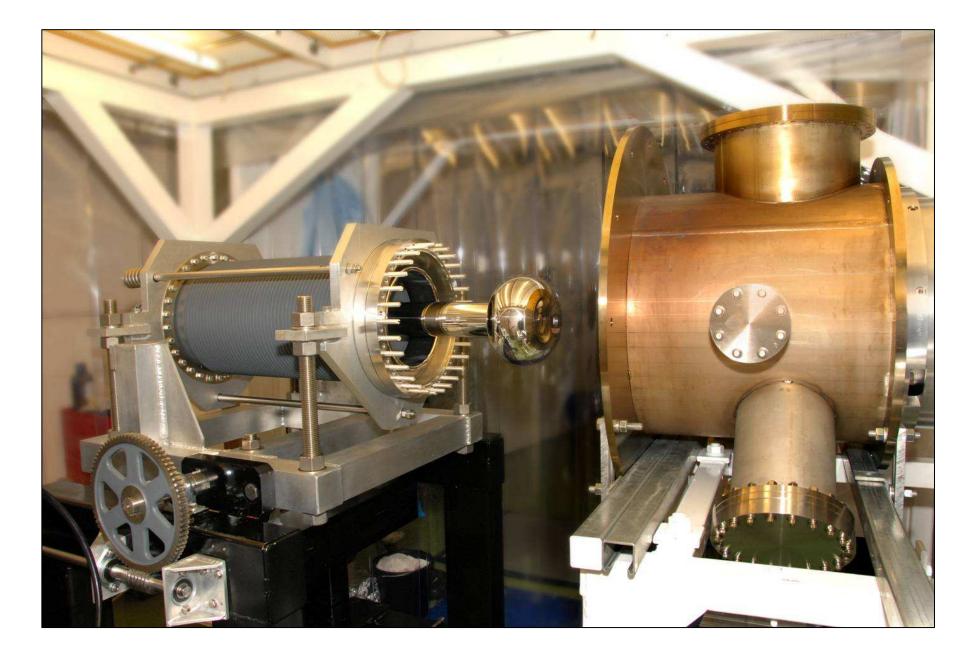




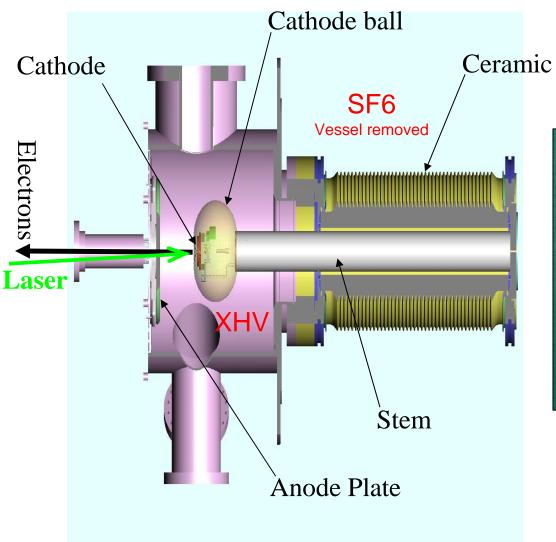




Daresbury Lab DC Photoemission Gun

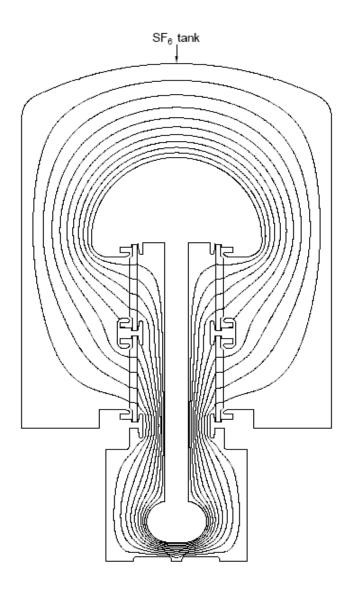


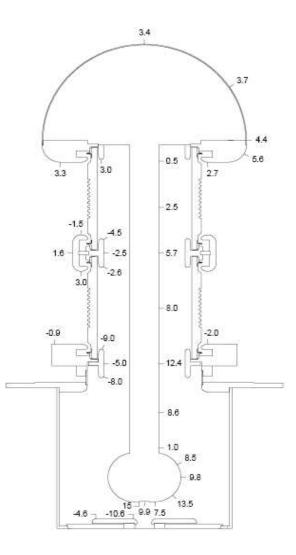
Gun Assembly



- JLab design Cs:GaAs cathode
- 500 kV DC supply
- Target transverse emittance: ~3 mm mrad





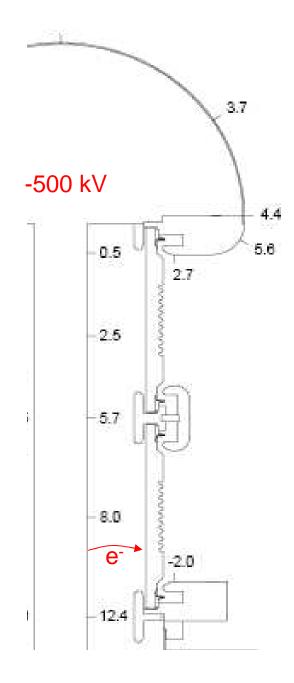


SF6 holds off 6MV/m at 1 atm



Insulators provide several functions:Isolate the HV electrodes from groundMechanical strengthUltra high vacuum

Only a few vendors worldwide available Expensive Long lead times



Problems with this geometry

The fields on the central support tube become quite high as it passes thru the flange at the bottom of the insulator

Electrons can be generated at sharp points or dust and accelerated into the insulator. The charge can build up and punch a hole thru the insulator.

Still trying to find an insulator design that has some resistivity to bleed off this charge

Inverted Gun Design

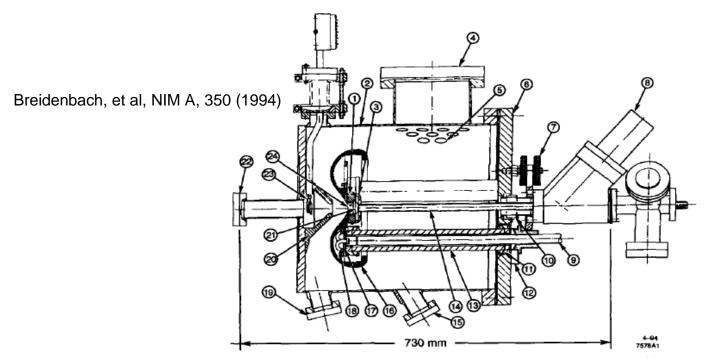
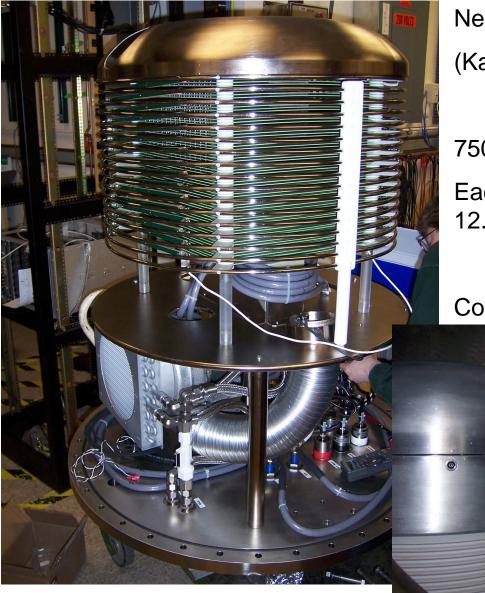


Fig. 1. Gun: (1) docking mechanism and puck holder, (2) gun body, (3) shield rings, (4) ion pump port, (5) pumping holes, (6) end flange, (7) jacks for aligning transporter to puck holder, (8) access valve, (9) high voltage cable, (10) bellows, (11) Kovar weld ring, (12) gas seal flange, (13) ceramic insulator, (14) transporter rod (only in place while changing photocathode), (15) docking window, (16) cathode electrode, (17) support plate, (18) gas tubes, (19) illumination window, (20) anode electrode, (21) puck, (22) exit port to beam line, (23) cesiator, (24) photocathode.



X-ray tube have been made like this for a long time – up to 350 kV 500kV Power Supply





New Technology for HV Power Supplies (Kaiser Systems)

750kV, 100 mA

Each circuit board produces 100mA, 12.5 kV

Cost: ~ \$10 per watt, \$750,000



Comparison of different gun types for accelerators

	SC RF	NC RF	DC
Avg Power	М	L	Н
Peak Power	М	Н	L
Charge/bunch	М	Н	L
Vacuum	XHV	HV	HV-XHV
Laser	Huge	Monster	Big
Cathodes	Metal, Metal(SC), antimonides	Metal, antimonides	Any
Cost	Enormous	Huge	depends